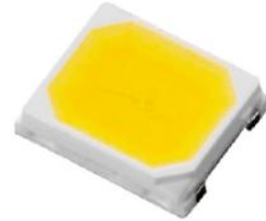


2835A03-XXH05-2P-F19-EC-LX Datasheet

This 2835 LED Light Source is a high performance energy efficient device which can handle high thermal and high driving current. The small package outline and high intensity make it an ideal choice for LED panel light, LED bulb light, LED tube light, backlighting and etc.



This part has a foot print that is compatible to most of the same size LED in the market today.

FEATURES

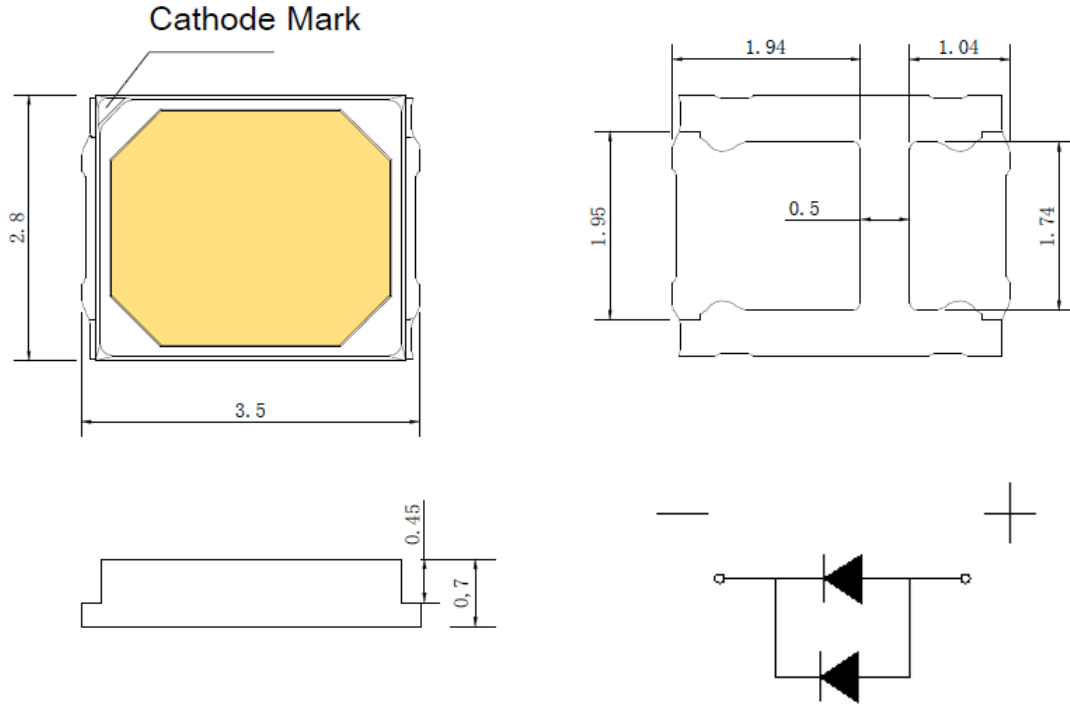
- Available in Cool White, Neutral White and Warm White color
- ANSI-compatible chromaticity bins
- High luminous Intensity and high efficiency
- Compatible with reflow soldering process
- Low thermal resistance
- Long operation life
- Wide viewing angle at 120°
- PCT package
- Environmental friendly, RoHS compliance

APPLICATIONS

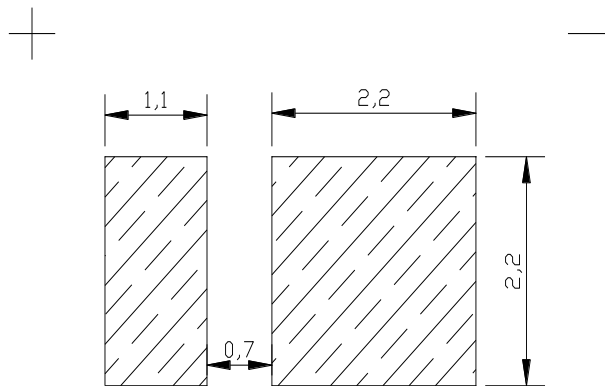
- Flat panel light
- LED tube light
- LED bulb light
- Decorative and landscape lighting
- Signage and channel letter
- Reading lamp
- Decorating and entertainment lighting
- Architectural lighting

Note: The information in this document is subject to change without notice.

PACKAGE DIMENSIONS



Recommended Solder Pad Design



Notes:

1. All dimensions in millimeters.
2. Thickness tolerance of copper plate is ± 0.02 mm.
3. Thickness tolerance of product is ± 0.05 mm.
4. Tolerance is ± 0.1 mm unless otherwise noted.

ABSOLUTE MAXIMUM RATINGS

Item	Symbol	Absolute Maximum Rating	Unit
Forward current	I_F	300	mA
Peak Forward Current ^[1]	I_{FP}	375	mA
Power Dissipation	P_d	500	mW
Operating Temperature	T_{opr}	-40~+85	°C
Storage Temperature	T_{stg}	-40~+100	°C
Soldering Temperature	T_{sld}	Reflow Soldering: 260°C for 10 seconds	
LED Junction Temperature	T_j	125	°C

Note:

I_{FP} Conditions: Pulse Width \leq 10msec. and Duty \leq 1/10.

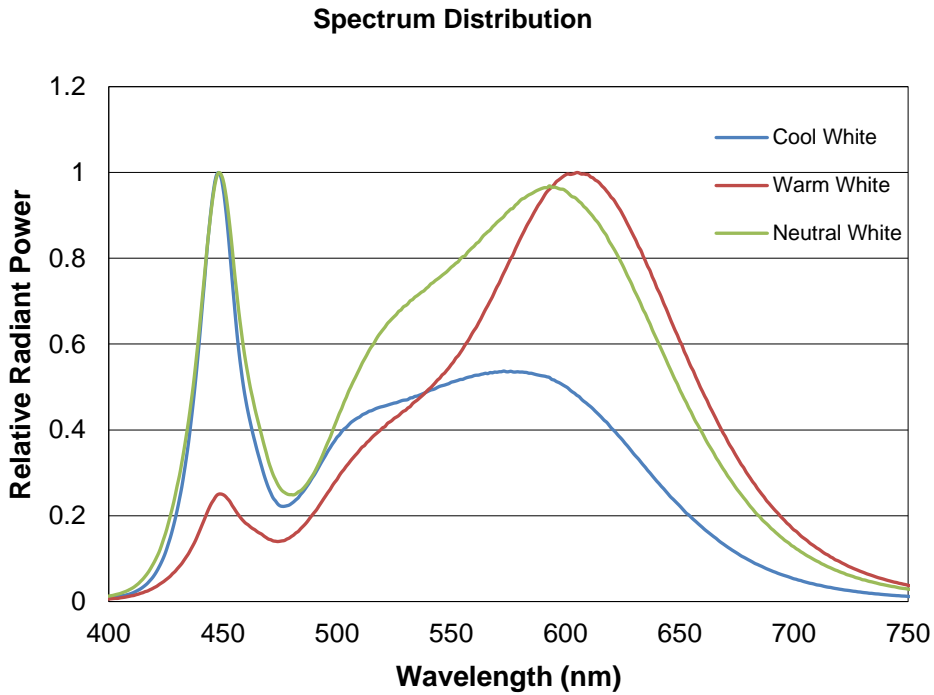
CHARACTERISTICS (T_j=25°C)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Forward Voltage ^[1]	V_F	$I_F=150mA$	2.8	--	3.0	V
Viewing Angle	$2\theta_{1/2}$	$I_F=150mA$	--	120	--	deg.
Luminous Flux	Φ_v	$I_F=150mA$	60	--	83	lm
Color Rendering Index	CRI	$I_F=150mA$	80	--	--	--
Color Temperature	CCT	$I_F=150mA$	2100	--	--	K
Thermal Resistance (Junction to Solder Point)	R_{th-js}	$I_F=150mA$	--	10	--	°C/W

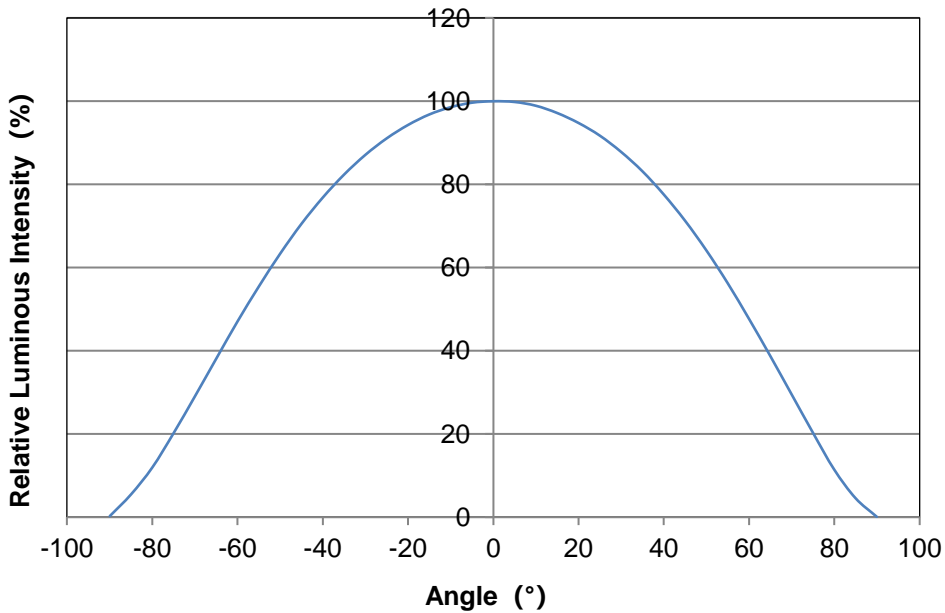
Notes:

- Luminous flux is measured with an accuracy of $\pm 10\%$.
- Chromaticity coordinate bins are measured with an accuracy of ± 0.01 .
- CRI is measured with an accuracy of ± 2 ;
- Some color and CRI bins may have limited availability, please contact us before ordering.
- All measurements were made under the standardized environment of Shineon

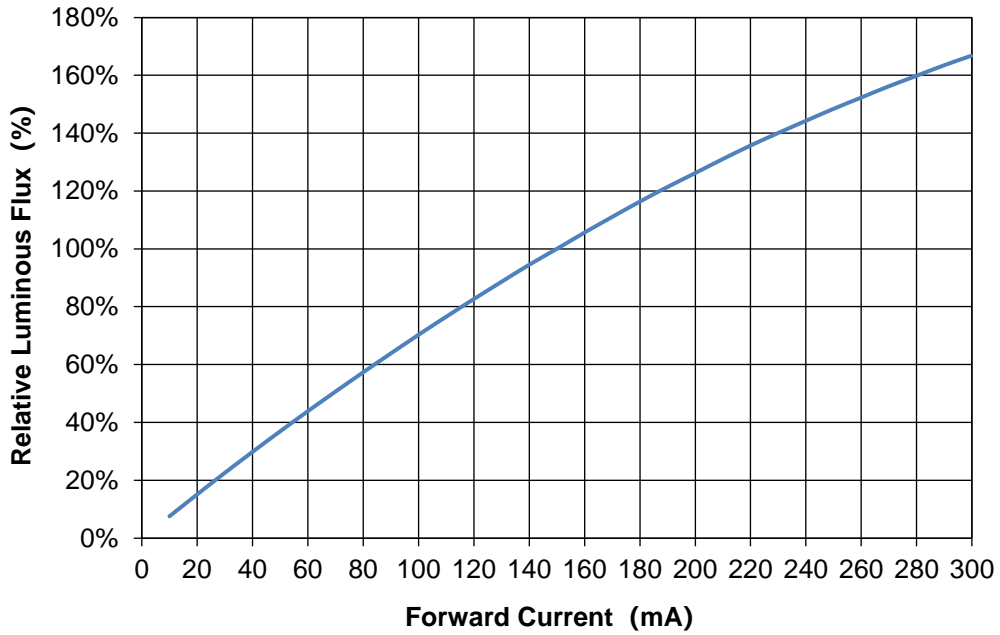
RELATIVE SPECTRAL POWER DISTRIBUTION (T_j=25°C)



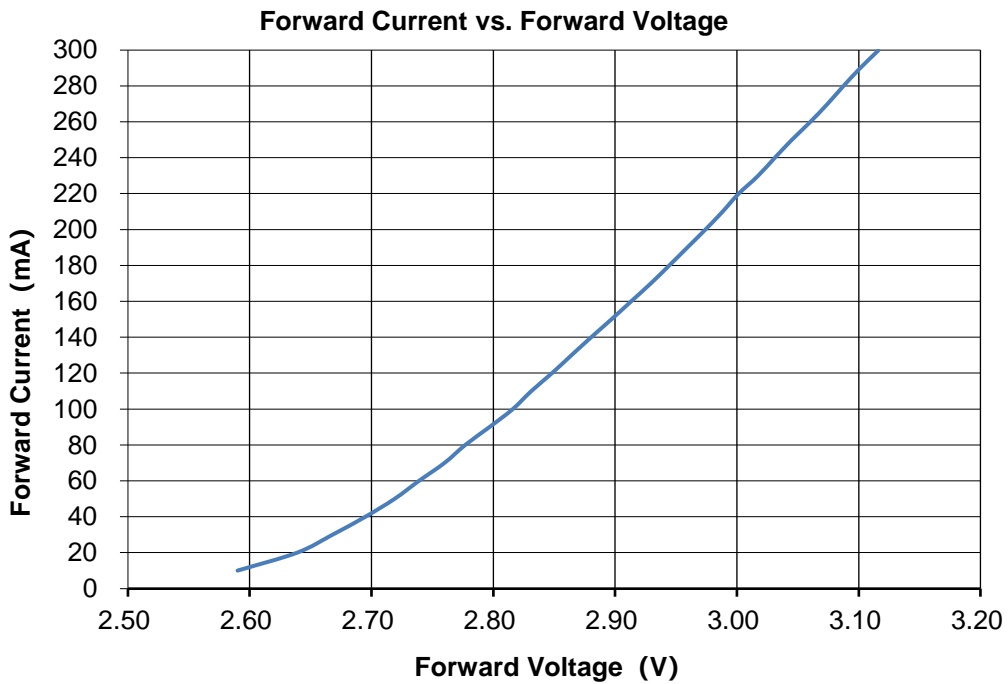
TYPICAL SPATIAL DISTRIBUTION



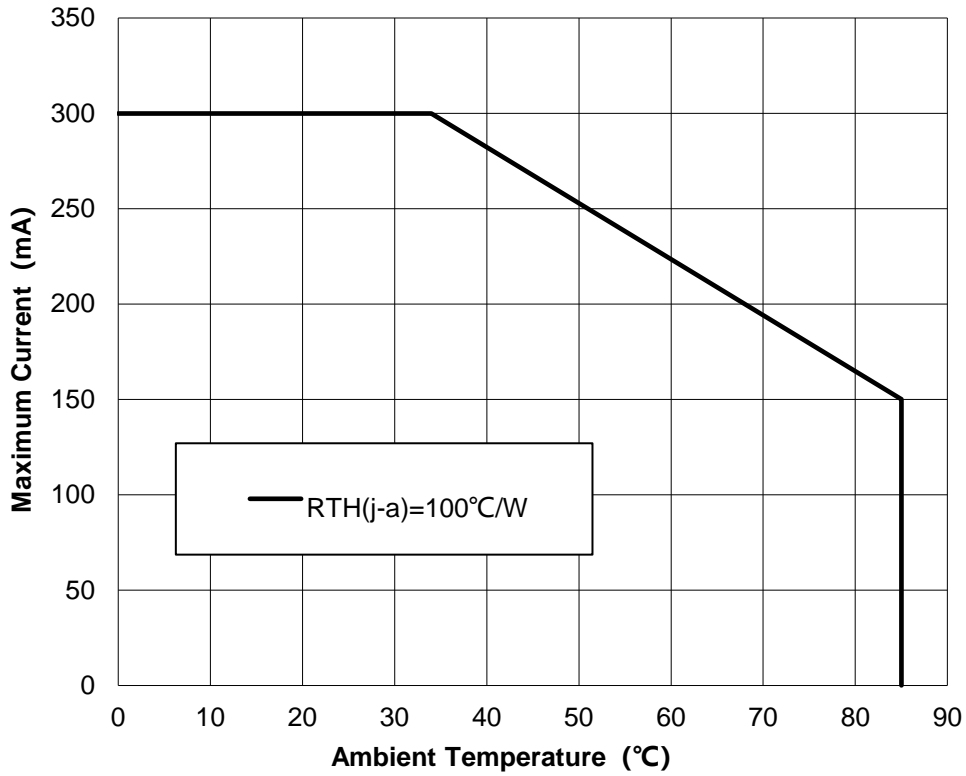
RELATIVE LUMINOUS FLUX VS. CURRENT ($T_j=25^{\circ}\text{C}$)



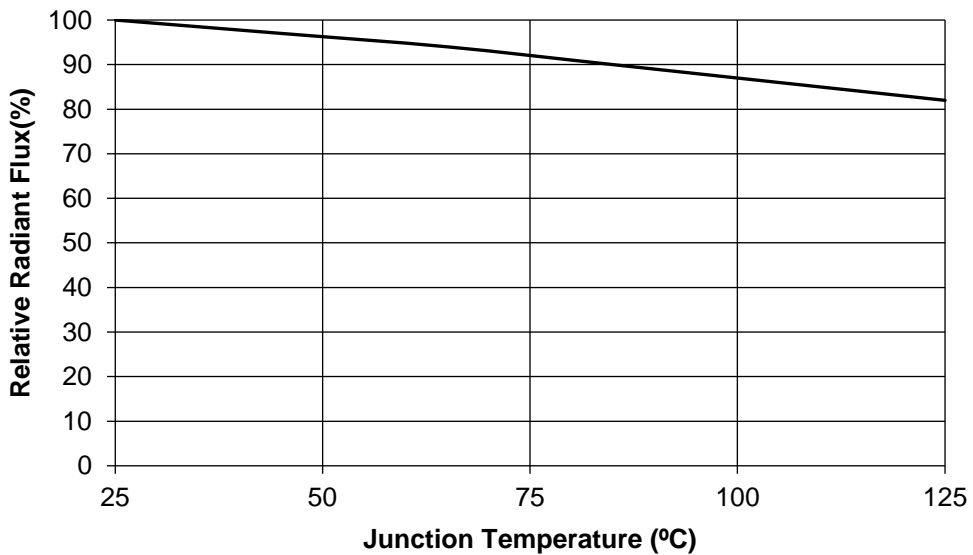
ELECTRICAL CHARACTERISTICS ($T_j=25^{\circ}\text{C}$)



MAXIMUM CURRENT VS. AMBIENT TEMPERATURE



RELATIVE RADIANT FLUX VS. JUNCTION TEMPERATURE



SORTING RANKS
(1) Luminous Flux (T_j=25°C)

Part Number	Condition	Rank	Unit
2835A03-22H05-2P-F19-EC-LX	150mA	P2	lm
		60-65	
2835A03-27H05-2P-F19-EC-LX		P33	
		68-73	
2835A03-30H05-2P-F19-EC-LX		P43	
		73-78	
2835A03-35H05-2P-F19-EC-LX		P5	
		75-80	
2835A03-40H05-2P-F19-EC-LX		P53	
		78-83	
2835A03-50H05-2P-F19-EC-LX		P53	
		78-83	
2835A03-57H05-2P-F19-EC-LX		P53	
		78-83	
2835A03-65H05-2P-F19-EC-LX	P53		
	78-83		
2835A03-100H05-2P-F19-EC-LX		P4	
		70-75	

(2) Forward Voltage (T_j=25°C)

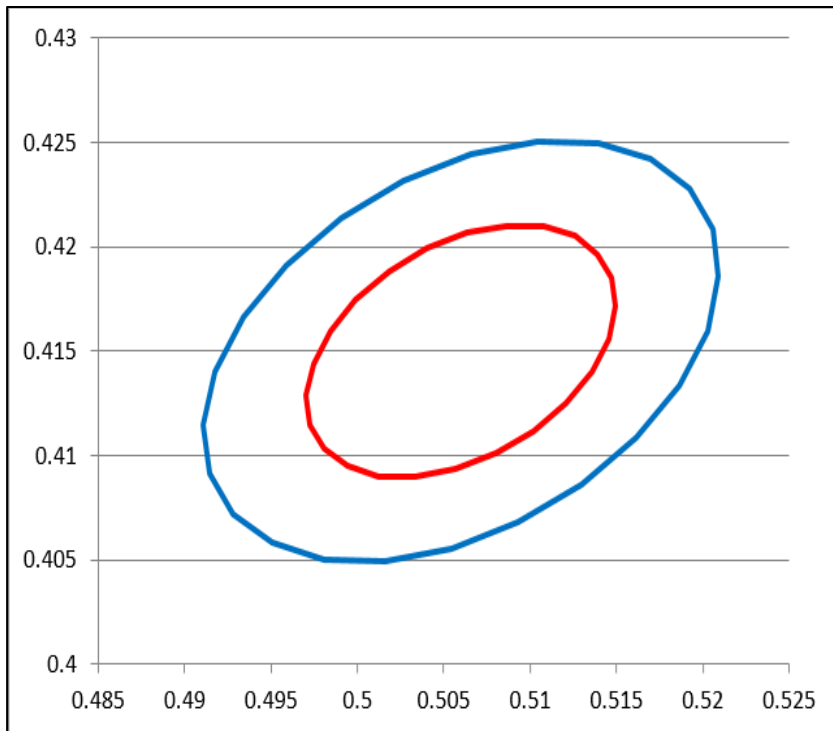
Rank	Condition	Min.	Max.	Unit
A8	150mA	2.8	2.9	V
A9		2.9	3.0	

Notes:

1. 10% tolerance for luminous intensity may be caused by measurement inaccuracy.
2. Measurement Uncertainty of the Forward Voltage : ± 0.05V

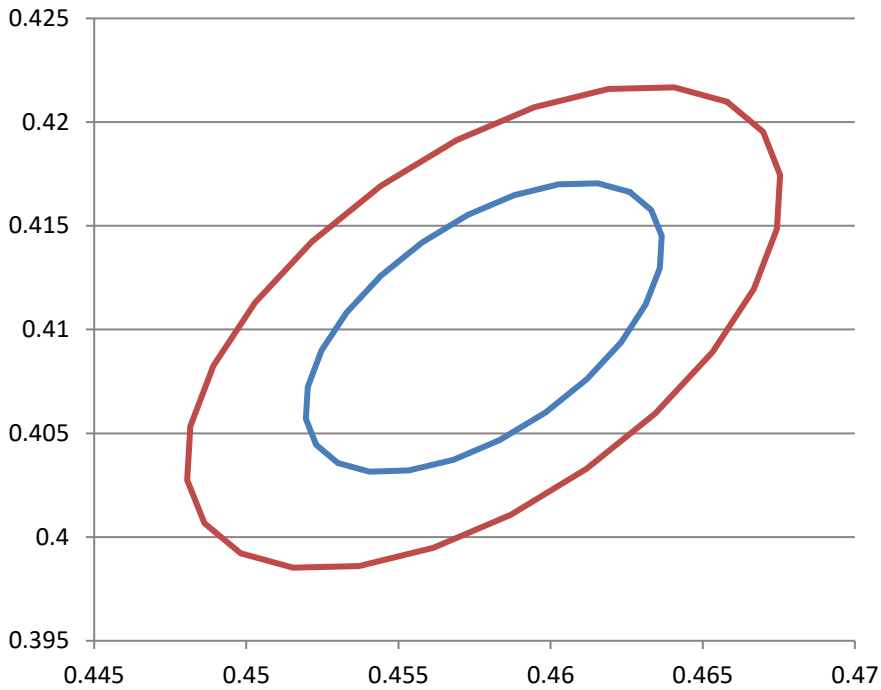
(3) Chromaticity Bins

Part Number	2835A03-22H05-2P-F19-EC-LX			CCT	2200K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
22-3	0.506	0.415	0.00706	0.00398	22
22-5			0.01177	0.00663	

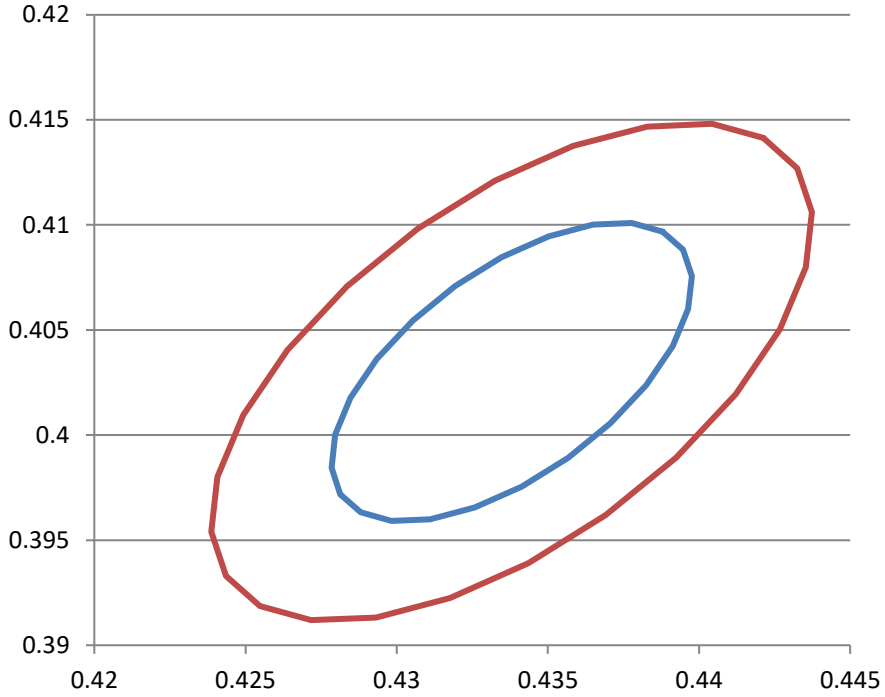


(3) Chromaticity Bins

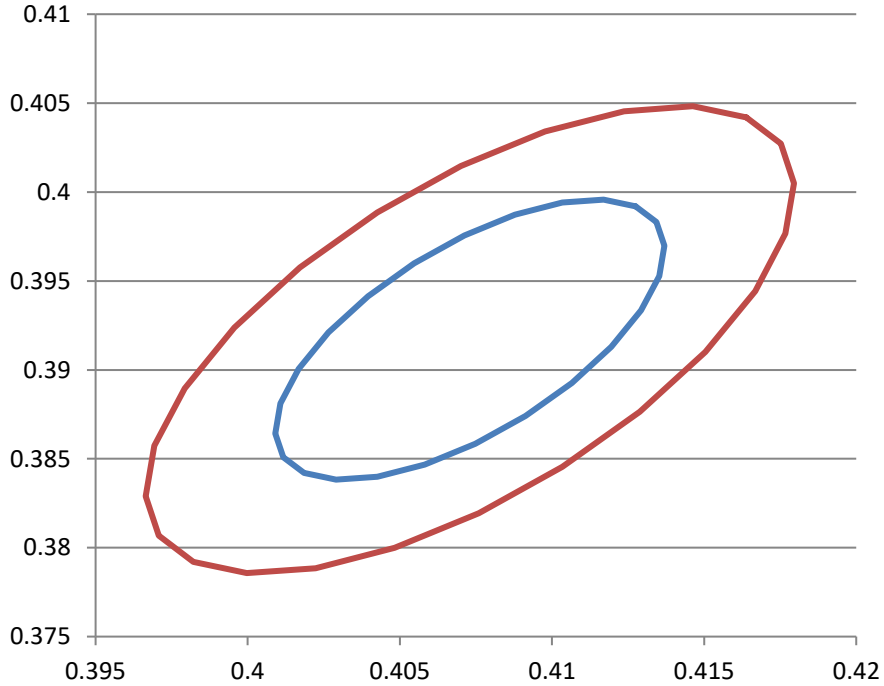
Part Number	2835A03-27H05-2P-F19-EC-LX		CCT	2700K	
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
27-3	0.4578	0.4101	0.00810	0.0042	53.7000
27-5			0.01350	0.0070	



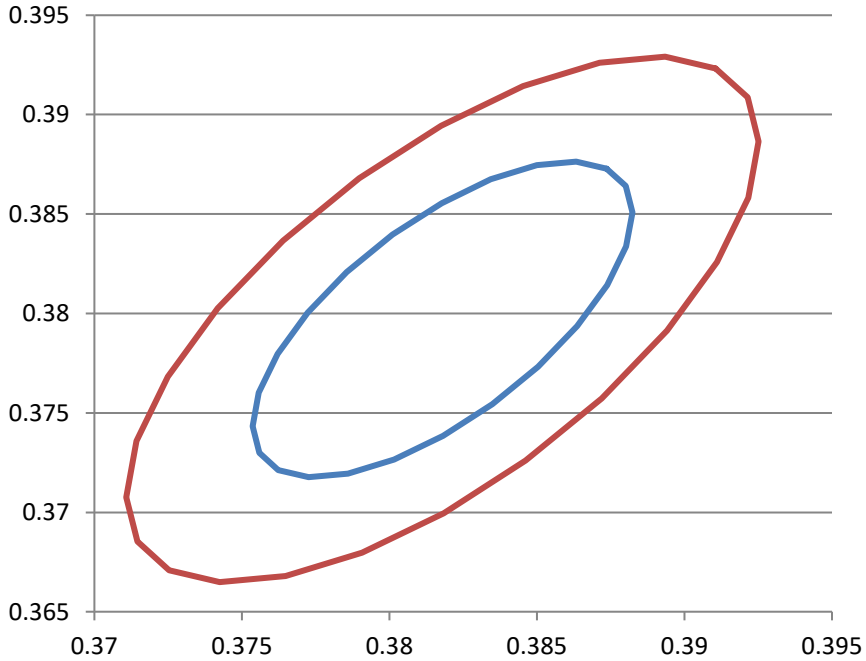
Part Number	2835A03-30H05-2P-F19-EC-LX			CCT	3000K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
30-3	0.4338	0.403	0.00834	0.00408	53.2200
30-5			0.0139	0.0068	



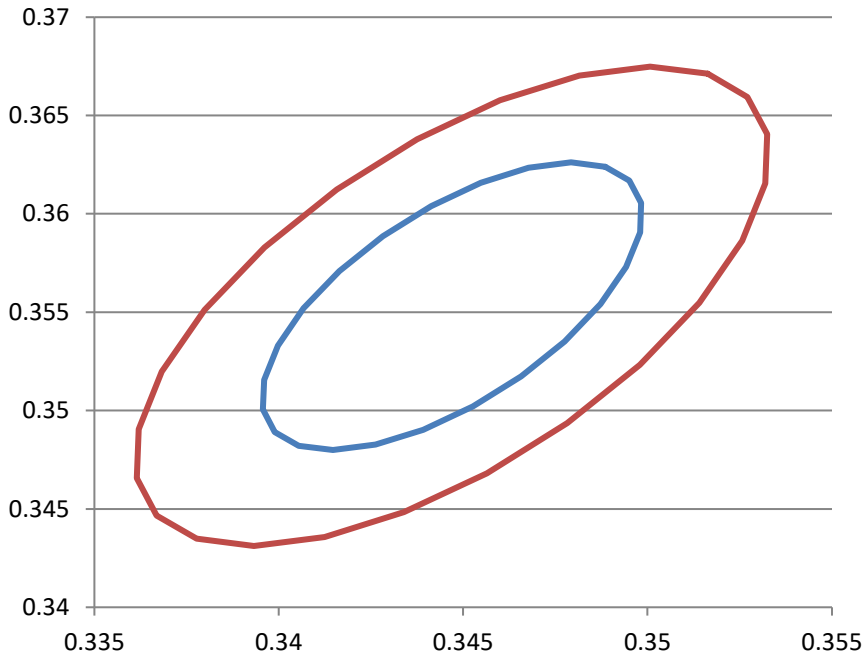
Part Number	2835A03-35H05-2P-F19-EC-LX			CCT	3500K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
35-3	0.4073	0.3917	0.00927	0.00414	54
35-5			0.01545	0.0069	



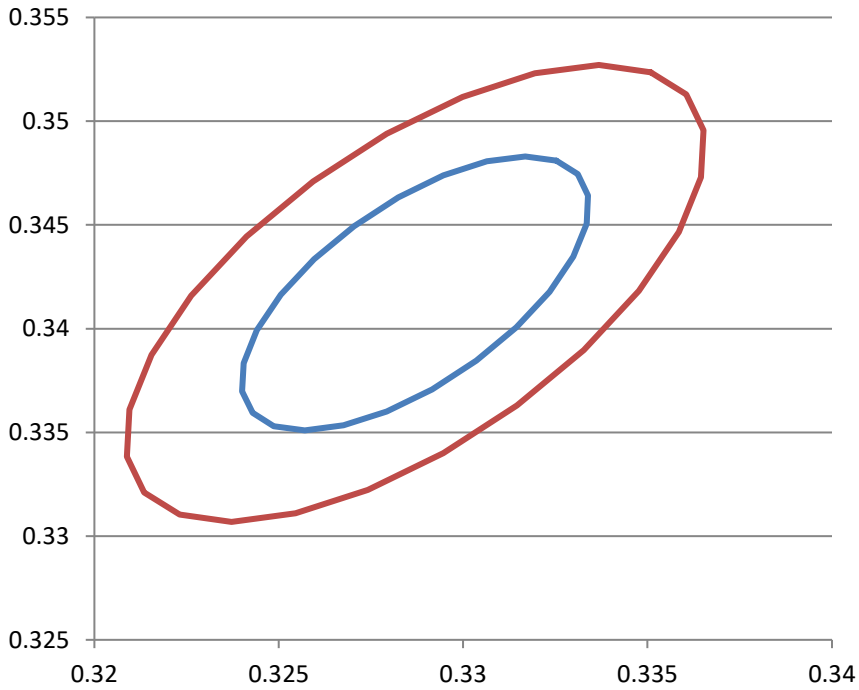
Part Number	2835A03-40H05-2P-F19-EC-LX			CCT	4000K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
40-3	0.3818	0.3797	0.00939	0.00402	53.2200
40-5			0.01565	0.0067	



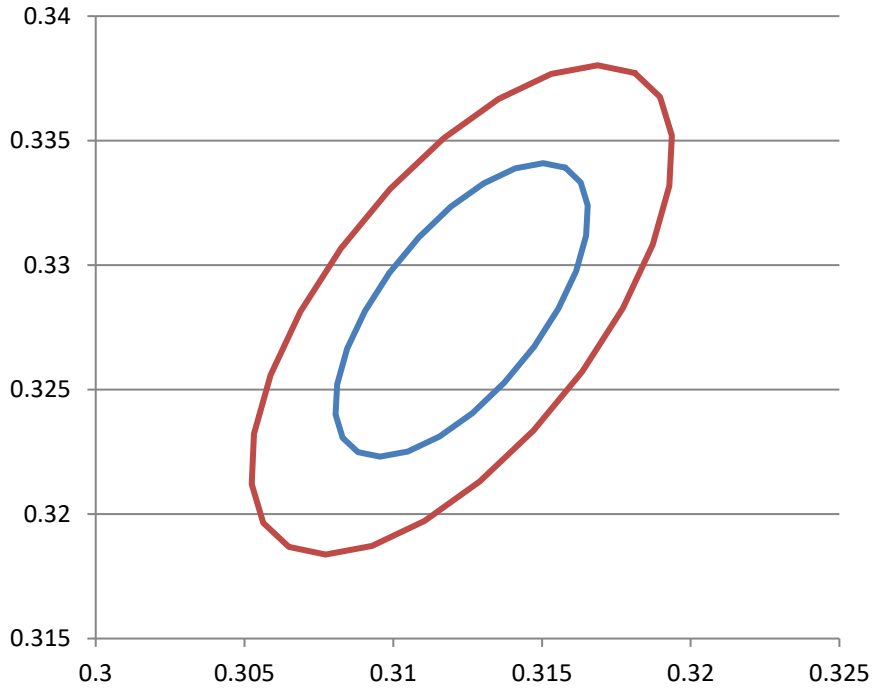
Part Number	2835A03-50H05-2P-F19-EC-LX			CCT	5000K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
50-3	0.3447	0.3553	0.00822	0.00354	59.62
50-5			0.0137	0.0059	



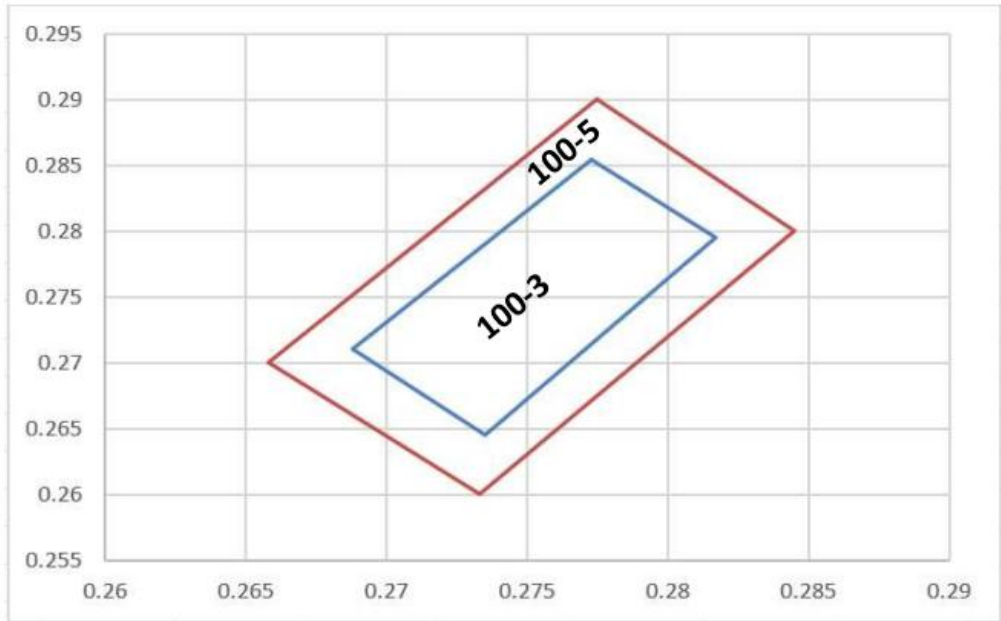
Part Number	2835A03-57H05-2P-F19-EC-LX				CCT	5700K
Bin Code	Color Coordinates(x,y)					
SDCM	x	y	a	b	Theta°	
57-3	0.3287	0.3417	0.00746	0.00312	59.09	
57-5			0.01243	0.00533		



Part Number	2835A03-65H05-2P-F19-EC-LX			CCT	6500K
Bin Code	Color Coordinates(x,y)				
SDCM	x	y	a	b	Theta°
65-3	0.3123	0.3282	0.00669	0.00285	58.57
65-5			0.01115	0.00475	



Part Number	2835A03-100H05-2P-F19-EC-LX		CCT	10000K	
Bin Code	Color Coordinates(x,y)				
100-3	x	0.2773	0.2817	0.2735	0.2688
	y	0.2855	0.2795	0.2645	0.271
100-5	x	0.2775	0.2845	0.2733	0.2658
	y	0.290	0.280	0.26	0.270



REFLOW SOLDERING CHARACTERISTICS

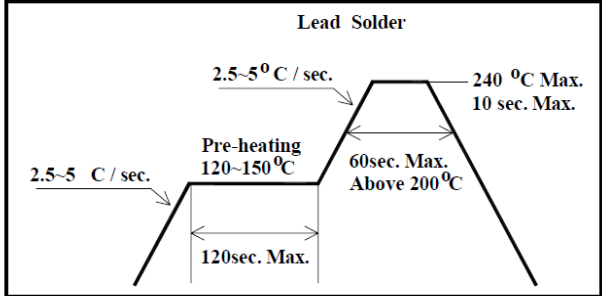
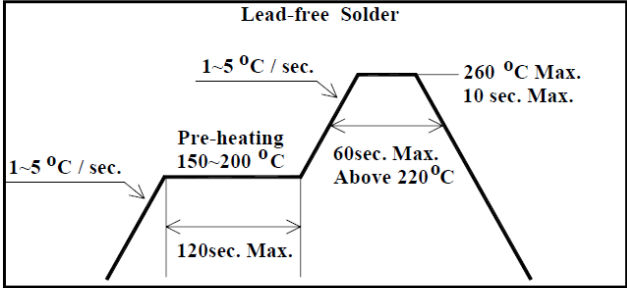
For Reflow Process:

Preheating : 140°C~160°C±5°C, within 2 minutes.

Operation heating : 260°C(Max.) within 10 seconds.(Max)

Gradual Cooling (Avoid quenching).

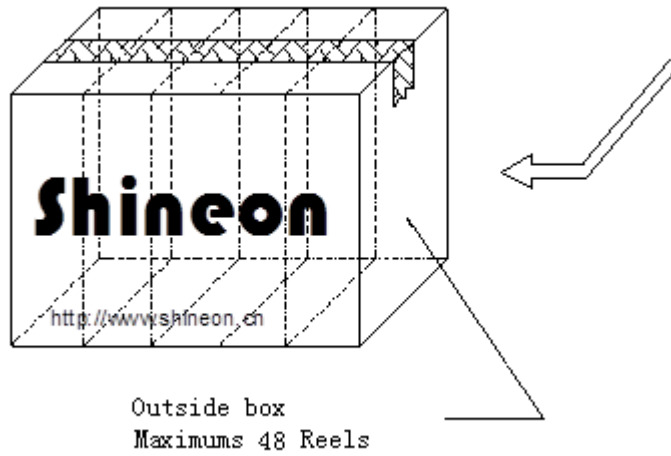
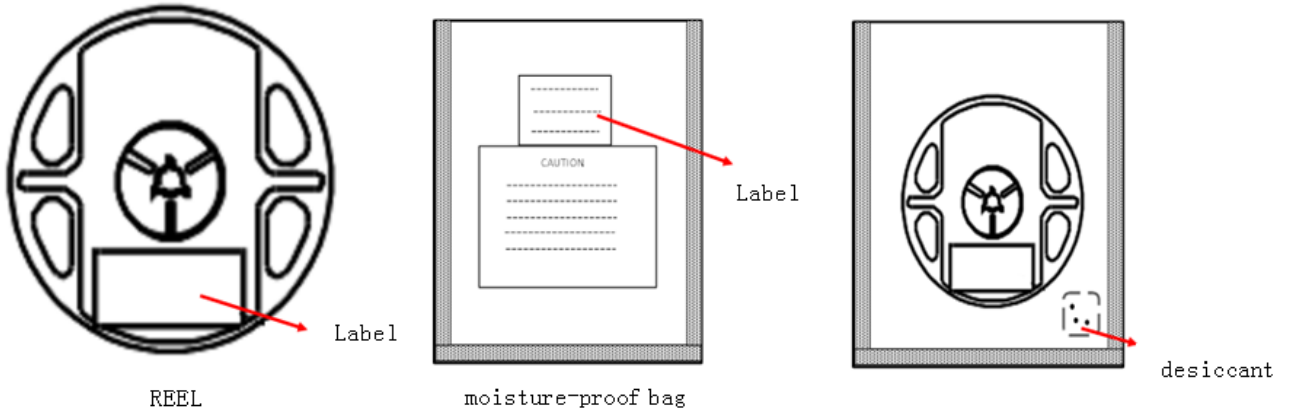
Lead solder		Lead-free solder	
Pre-heat	120-150°C	Pre-heat	150-200°C
Pre-heat time	120 sec.Max.	Pre-heat time	120 sec.Max.
Peak Temperature	240°C Max.	Peak Temperature	260°C Max.
Soldering time condition	10 sec.Max.	Soldering time condition	10 sec.Max.

Lead Solder	Lead-free Solder
 <p>The diagram shows a reflow profile for Lead Solder. It starts with a heating phase at 2.5-5 °C/sec. This is followed by a pre-heating phase at 120-150 °C for a maximum of 120 seconds. The temperature then rises to a peak of 240 °C at 2.5-5 °C/sec, where it is held for a maximum of 10 seconds. The cooling phase is gradual, with a maximum of 60 seconds above 200 °C.</p>	 <p>The diagram shows a reflow profile for Lead-free Solder. It starts with a heating phase at 1-5 °C/sec. This is followed by a pre-heating phase at 150-200 °C for a maximum of 120 seconds. The temperature then rises to a peak of 260 °C at 1-5 °C/sec, where it is held for a maximum of 10 seconds. The cooling phase is gradual, with a maximum of 60 seconds above 220 °C.</p>

Notes:

The encapsulated material of the LEDs is silicone . Therefore the LEDs have a soft surface on the top of package. The pressure to the top surface will be influence to the reliability of the LEDs. Precautions should be taken to avoid the strong pressure on the encapsulated part. So when using the picking up nozzle, the pressure on the silicone resin should be proper.

PACKAGING



Reliability Test Items

Test Items	Test Duration	Number of Damaged
Steady State Operating Life of High Temperature (HTOL) Ts=85°C, IF=Max	1000hrs	0/20
Steady State Operating Life of Low Temperature (LTOL) Ta=-40°C, IF=Max	1000hrs	0/20
High Temperature Storage (HTS) 100°C	1000hrs	0/20
Low Temperature Storage (LTS) -40°C	1000hrs	0/20
Thermal Shock (TS) -45°C~125°C 30min dwell 20sec transfer	200cycles	0/20
Solder Resistance (SR) 265°C, 3X MSL	5sec	0/20
Solder Ability (SA) 245°C5sec, 95% coverage	5sec	0/11

Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward	Vf	IF=Typical Current		U.S.L x1.1
Luminous Flux	lm	IF=Typical Current	L.S.L x0.7	
CCX&CCY	x,y	IF=Typical Current		Shift<0.02

PRECAUTION FOR USE

- (1) This device should not be used in any type of fluid such as water, oil, organic solvent, etc. When washing is required, IPA should be used.
- (2) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.
- (3) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from ShineOn, a sealed container with a nitrogen atmosphere should be used for storage.
- (4) The LEDs must be used within seven days after opening the moisture proof packing. Repack unused Products with anti-moisture packing, fold to close any opening and then store in a dry place.
- (5) The appearance and specifications of the product may be modified for improvement without notice.
- (6) This LED is sensitive to the static electricity and surge. It is recommended to use a wrist Band or anti-electrostatic glove when handling the LEDs.
- (7) On manual soldering, a solder tip must be needed as grounded for usage. If over voltage which exceeds the absolute maximum rating is applied to LEDs, it will cause damage LEDs and result in destruction. Damaged LEDs will show some unusual characteristics such as leak current remarkably increase ,turn-on voltage becomes lower and the LEDs get unlighted at low current.